

Title (en)

Device and method for sealing the space between the wall and floor when insulating rooms

Title (de)

Vorrichtung und Verfahren zur Abdichtung zwischen Wand und Boden an der Isolierung bei Räumen

Title (fr)

Dispositif et procédé destinés à réaliser une étanchéification entre le mur et le sol au niveau de l'isolation dans des pièces

Publication

**EP 2634514 A3 20161019 (DE)**

Application

**EP 13000992 A 20130227**

Priority

DE 102012003849 A 20120229

Abstract (en)

[origin: EP2634514A2] The device has a base element (5a) that is integrally connected with a wall panel (5) and is installed on floor (2). A moisture barrier (16) is arranged on bottom portion and is provided with an edge section (17) guided upwards along the base element. The floor coverings (18,25) are arranged on the moisture barrier. The height of the base element in vertical direction is larger than the sum of thickness of the moisture barrier and thickness of the floor coverings. The distance between the wall panel and base element is larger than the thickness of the moisture barrier. An independent claim is included for method for sealing between wall and floor in insulation space.

IPC 8 full level

**F25D 13/00** (2006.01); **E04B 1/62** (2006.01)

CPC (source: EP)

**F25D 13/00** (2013.01); **E04B 1/7675** (2013.01)

Citation (search report)

- [XYI] US 2002014046 A1 20020207 - KORN DORIS [DE]
- [Y] DE 29808932 U1 19980820 - DOERKEN EWALD AG [DE]

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

**EP 2634514 A2 20130904; EP 2634514 A3 20161019; EP 2634514 B1 20190213**; DE 102013003237 A1 20130829; ES 2725311 T3 20190923

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